

Microprocessor Reset Circuit



SOT-23

Pin Definition:

H

TS809/TS810 TS809R/TS810R 1. Ground 1. RESET(RESET)

<u>RESET</u>(RESET)
 Ground
 Vcc
 Vcc

General Description

The TS809/810 series are microprocessor (μ P) supervisory circuit used to monitor the power supplies in μ P and digital systems. They provide excellent circuit reliability and low cost by eliminating external components and adjustments when used with +5V, +3.3V, +3.0V powered circuits. These circuits perform a single function: they assert a reset signal whenever the VCC supply voltage declines below a preset threshold, keeping it asserted for at least 140ms after VCC has risen above the reset threshold. Reset thresholds suitable for operation with a variety of supply voltages are available. The TS809/810 series have push pull outputs. The TS809/809R have an active low RESET output, while the TS810/810R has an active high (RESET) output. The reset comparator is designed to ignore fast transients on VCC, and the output guaranteed to be in the correct logic state for VCC down to 1V. Low supply correct makes the TS809/810 series ideal for use in portable equipment.

Features

- Highly Accurate: ±2%
- Precision monitoring of +3V, +3.3V and +5V power supply voltage
- Fully specified over temperature
- Available in three output configurations
- Push-Pull <u>RESET</u> low output (TS809/TS809R)
- Push-Pull (RESET) high output (TS810/TS810R)
- 140mS min. power-on reset pulse width
- 12uA supply current
- Guaranteed reset valid to Vcc = +1V
- Power supply transient immunity
- No external components

Applications

- Battery-operated systems
- Controllers
- Intelligent instruments
- Critical uP and uC power monitoring
- Portable / Battery powered equipment
- Automotive

Pin Descriptions

Name	Description			
Gnd	Ground			
RESET	RESET - TS809 / TS809R (Active Low)			
(RESET)	(RESET) – TS810 / TS810R (Active High)			
Vcc	Operating voltage input			

Ordering Information

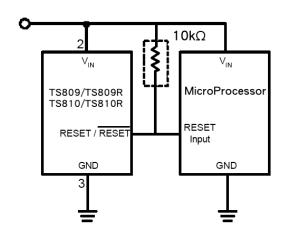
Part No.	Package	Packing
TS809CX <u>x</u> RF	SOT-23	3Kpcs / 7" Reel
TS810CX <u>x</u> RF	SOT-23	3Kpcs / 7" Reel
TS809RCX <u>x</u> RF	SOT-23	3Kpcs / 7" Reel
TS810RCX <u>x</u> RF	SOT-23	3Kpcs / 7" Reel

Note: **x** is the threshold voltage type, option as

A:4.63V **B**:4.38V **C**:4.00V **D**:3.08V **E**:2.93V **F**:2.63V **G**:2.32V **H**:2.1V

I : 2.0V

Application Circuit





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Absolute Maximum Rating

Parameter	Symbol	Maximum	Unit	
Terminal Voltage (with respect to Gnd)	V _{CC}	7	V	
RESET & (RESET) push-pull	V_{RESET}	- 0.3 ~ (VCC +0.3)	V	
Input Current, V _{CC}	Icc	20	mA	
Output Current, RESET, (RESET)	Io	20	mA	
Rate of Rise, V _{CC}	V_R	100	V/uS	
Continuous Power Dissipation	P _D	320	mW	
Operating Junction Temperature Range	T _{OPR}	-40 ~ +125	°C	
Storage Temperature Range	T _{STG}	-65 ~ +150	°C	
Lead Soldering Temperature (260°C)	T_LEAD	10	S	

Electrical Specifications (Ta = 25°C, unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Input Supply Voltage	Ta=-40°C~+85°C	V _{CC}	1.0		5.5	V
Complex Compant	V _{IN} =V _{IN} *1.10				3.0	uA
Supply Current	V _{IN} =V _{IN} *1.10, Ta=-40°C~+85°C	- I _{cc}	-		5.0	
	TS809/809R/810/810RCXA		4.56	4.63	4.7	
	TS809/809R/810/810RCXB		4.31	4.38	4.45	
	TS809/809R/810/810RCXC		3.94	4.00	4.06	
	TS809/809R/810/810RCXD		3.03	3.08	3.13	V
Reset Threshold	TS809/809R/810/810RCXE	V_{TH}	2.89	2.93	2.97	
	TS809/809R/810/810RCXF		2.59	2.63	2.67	
	TS809/809R/810/810RCXG		2.28	2.32	2.35	
	TS809CXH		2.07	2.1	2.13	
	TS809CXI		1.97	2.0	2.03	
Reset Threshold Temperature Coefficient			30	50	160	ppm/ °C
VCC to Reset Delay	V _{CC} = V _{TH} - 100mV	T _		40		uS
Reset Active Timeout Period	Ta=-40°C~+85°C	T _{DELAY}	140	210	500	mS
RESET Output (TS809/R) Voltage Low	V _{CC} < V _{TH(MAX)} , I _{SINK} =1.2mA	V _{OL}			0.2	V
RESET Output (TS809/R) Voltage High	$\begin{aligned} &V_{\text{CC}} > V_{\text{TH(MAX)}}, \ I_{\text{SOURCE}} = &0.5 \text{mA}, \\ &V_{\text{CC}} > 1.8 \text{V} \\ &V_{\text{CC}} > V_{\text{TH(MAX)}}, \ I_{\text{SOURCE}} = &0.15 \text{mA}, \end{aligned}$	V _{OH}	0.8 VCC			V
	1.8V ≥ V _{CC} >1.0V					
(RESET) Output (TS810/R) Voltage Low	$V_{CC} > V_{TH(MAX)}$, $I_{SINK} = 1.2 \text{mA}$	V _{OL}			0.2	V
(RESET) Output (TS810/R)	$V_{CC} < V_{TH(MAX)}$, $I_{SOURCE} = 0.5 \text{mA}$, $V_{CC} > 1.8 \text{V}$		0.8			V
Voltage High	$V_{CC} > V_{TH(MAX)}$, $I_{SOURCE} = 0.15$ mA, 1.8 V $\geq V_{CC} > 1.0$ V	V _{OH}	VCC			V



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Application Note

Function Description

A microprocessor's (μ P's) reset input starts the μ P In a know state. The TS809/810/809R/810R assert reset to prevent code-execution errors during power-up, power-down, or brownout conditions. They assert a reset signal whenever the Vcc supply voltage declines below a preset threshold, keeping it asserted for at least 140ms after Vcc has risen above the reset threshold. The TS809/810/809R/810R have a push-pull output stage.

Applications Information

Negative-Going VCC transients in addition to issuing a reset to the μP during power-up, power-down, and brownout conditions, the TS809/810 are relatively immune to short-duration negative-going Vcc transients (glitches).

The TS809/810/809R/810R do not generate a reset pulse. The graph was generated using a negative going pulse applied to Vcc, starting 0.5V above the actual reset threshold and ending below it by the magnitude indicated (reset comparator overdrive). The graph indicates the maximum pulse width a negative going Vcc transient can have without causing a reset pulse. As the magnitude of the transient increases (goes farther below the reset threshold), the maximum allowable pulse width decreases. Typically, a Vcc transient that goes 100mV below the reset threshold and lasts 20µS or less will not cause a reset pulse. A 0.1µF bypass capacitor mounted as close as possible to the Vcc pin provides additional transient immunity.

Ensuring a Valid Reset Output Down to Vcc=0

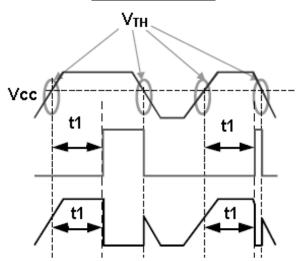
When Vcc falls below 1V, the TS809/810/809R/810R reset output no longer sinks current - it becomes an open circuit. Therefore, high impedance CMOS logic input connected to reset can drift to undetermined voltages.

This present no problem in most applications since most μP and other circuitry is inoperative with Vcc below 1V.However, in applications where reset must be valid down to 0V, adding a pull down resistor to reset causes and stray leakage currents to flow to ground, holding reset low (Figure 2.) R1's value is not critical; 100K is large enough not to load reset and small enough to pull RESET to ground. For the TS809/810/809R/810R if reset is required to remain valid for Vcc<1V.

Benefits of Highly Accurate Reset Threshold

Most μP supervisor ICs has reset threshold voltages between 5% and 10% below the value of nominal supply voltages. This ensures a reset will not occur within 5% of the nominal supply, but will occur when the supply is 10% below nominal. When using ICs rated at only the nominal supply $\pm 5\%$, this leaves a zone of uncertainty where the supply is between 5% and 10% low, and where the reset many or may not be asserted

Timming Diagram

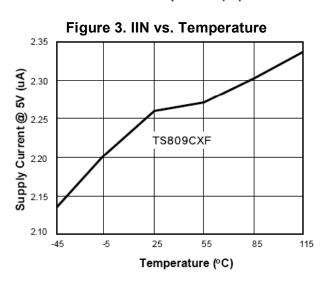


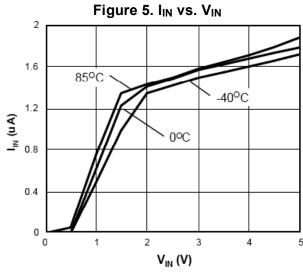


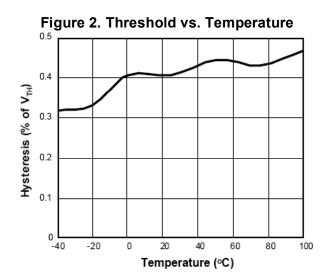
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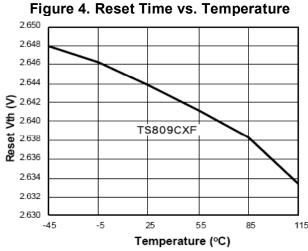
Electrical Characteristics Curve

Figure 1. Reset Time vs. Temperature 215 210 Reset Time (mS) 205 TS809CXF 200 195 190 -5 115 Temperature (°C)









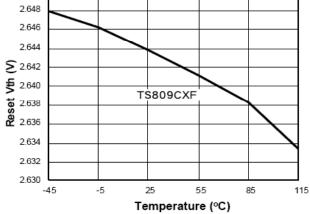
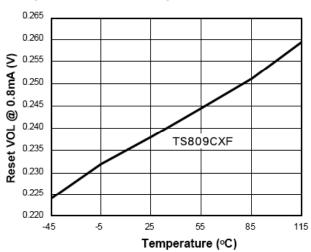


Figure 6. Reset Voltage vs. Temperature

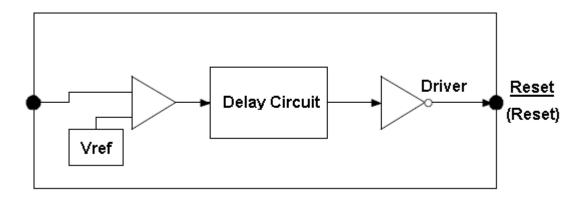




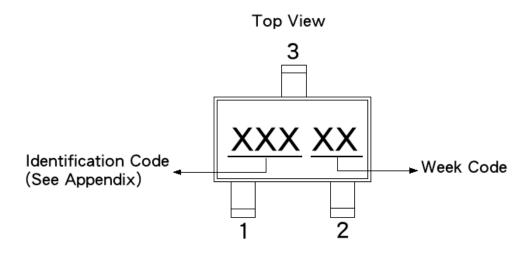
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Function Block



Marking Information



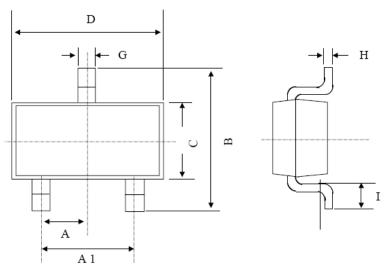
Part No.	Identification Code	Part No.	Identification Code	Part No.	Identification Code	Part No.	Identification Code
TS809CXA	ARK	TS810CXA	ARJ	TS809RCXA	ABA	TS810RCXA	ACA
TS809CXB	ARN	TS810CXB	ALS	TS809RCXB	ABB	TS810RCXB	ACB
TS809CXC	ASB	TS810CXC	AAC	TS809RCXC	ATQ	TS810RCXC	ACC
TS809CXD	ASA	TS810CXD	ASU	TS809RCXD	ATO	TS810RCXD	ACD
TS809CXE	AMO	TS810CXE	ALV	TS809RCXE	AUV	TS810RCXE	ACE
TS809CXF	AMP	TS810CXF	AZM	TS809RCXF	ABF	TS810RCXF	ACF
TS809CXG	ATT	TS810CXG	AAG	TS809RCXG	ABG	TS810RCXG	ACG
TS809CXH	ASK						
TS809CXI	BDT						



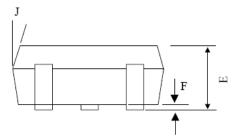
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SOT-23 Mechanical Drawing



SOT-23 DIMENSION					
DIM	MILLIM	ETERS	INCHES		
DIIVI	MIN	MIN MAX MIN		MAX.	
Α	0.95 BSC		C 0.037 BSC		
A1	1.9 I	BSC	0.074	BSC	
В	2.40	3.00	0.094	0.118	
С	1.40	1.80	0.055	0.070	
D	2.70	3.10	0.106	0.122	
Е	1.00	1.40	0.039	0.055	
F	0.00	0.15	0.000	0.059	
G	0.35	0.50	0.014	0.020	
Н	0.09	0.25	0.003	0.009	
I	0.35 BSC		0.0138	BSC	
J	5°	10°	5°	10°	





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